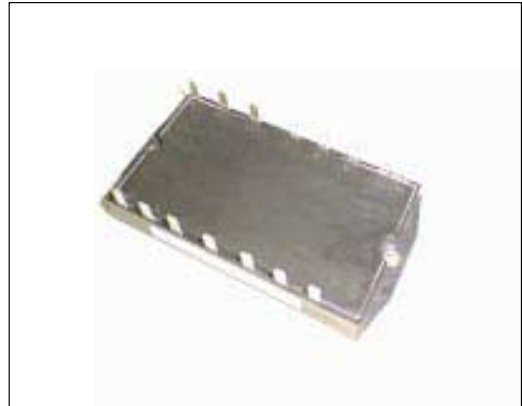


IGBT MODULE

600V / 50A / PIM



■ Features

- High Speed Switching
- Voltage Drive
- Low Inductance Module Structure
- Converter Diode Bridge Dynamic Brake Circuit

■ Applications

- Inverter for Motoe Drive
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply

■ Maximum ratings and characteristics

● Absolute maximum ratings (Tc=25°C unless without specified)

Item		Symbol	Condition	Rating	Unit
Inverter	Collector-Emitter voltage	V _{CES}		600	V
	Gate-Emitter voltage	V _{GES}		±20	V
	Collector current	I _C	Continuous	50	A
		I _{CP}	1ms	100	A
		-I _C		50	A
Collector power dissipation	P _C	1 device	200	W	
Brake	Collector-Emitter voltage	V _{CES}		600	V
	Gate-Emitter voltage	V _{GES}		±20	V
	Collector current	I _C	Continuous	50	A
		I _{CP}	1ms	100	A
	Collector power dissipation	P _C	1 device	200	W
	Repetitive peak reverse voltage	V _{R_{RM}}		600	V
	Average forward current	I _{F(AV)}		1	A
	Surge current	I _{FSM}	10ms	50	A
Converter	Repetitive peak reverse voltage	V _{R_{RM}}		800	V
	Non-Repetitive peak reverse voltage	V _{R_{SM}}		900	V
	Average output current	I _O	50Hz/60Hz sine wave	50	A
	Surge current (Non-Repetitive)	I _{FSM}	T _j =150°C, 10ms	350	A
	I ² t (Non-Repetitive)		T _j =150°C, 10ms	648	A ² s
	Operating junction temperature	T _j		+150	°C
Storage temperature	T _{stg}		-40 to +125	°C	
Isolation voltage	V _{iso}	AC : 1 minute	AC 2500	V	
Mounting screw torque			1.7 * ₁	N·m	

*₁ Recommendable value : 1.3 to 1.7 N·m (M4)

● Electrical characteristics (T_j=25°C unless without specified)

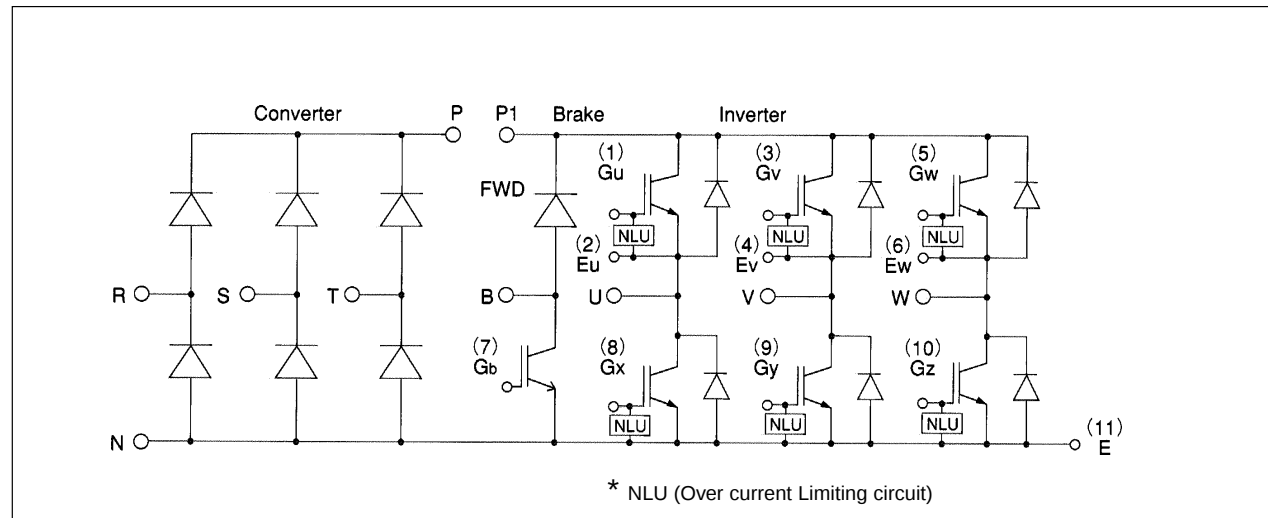
Item	Symbol	Condition	Characteristics			Unit
			Min.	Typ.	Max.	
Inverter (IGBT)	Zero gate voltage collector current	ICES	VCE=600V, VGE=0V			1.0 mA
	Gate-Emitter leakage current	IGES	VCE=0V, VGE=±20V			20 µA
	Gate-Emitter threshold voltage	VGE(th)	VCE=20V, IC=50mA			4.5 V
	Collector-Emitter saturation voltage	VCE(sat)	VGE=15V, IC=50A			2.8 V
	Collector-Emitter voltage	-VCE	-IC=50A			3.0 V
	Input capacitance	Cies	VGE=0V, VCE=10V, f=1MHz			3300 pF
	Switching time	ton	VCC=300V			1.2 µs
		tr	IC=50A			0.6 µs
		toff	VGE=±15V			1.0 µs
		tf	RG=51 ohm			0.35 µs
Brake (IGBT)	Reverse recovery time of FRD	trr	IF=50A			0.3 µs
	Zero gate voltage collector current	ICES	VCE=600V, VGE=0V			1.0 mA
	Gate-Emitter leakage current	IGES	VCE=0V, VGE=±20V			0.1 µA
	Collector-Emitter saturation voltage	VCE(sat)	IC=50A, VGE=15V			2.8 V
	Switching time	ton	VCC=300V			0.8 µs
		tr	IC=50A			0.6 µs
		toff	VGE=±15V			1.0 µs
Brake (FWD)	Reverse current	IRRM	VR=600V			1.0 mA
	Reverse recovery time	trr				0.6 µs
Converter	Forward voltage	VFM	IF=50A			1.55 V
	Reverse current	IRRM	VR=800V			1.0 mA

● Thermal Characteristics

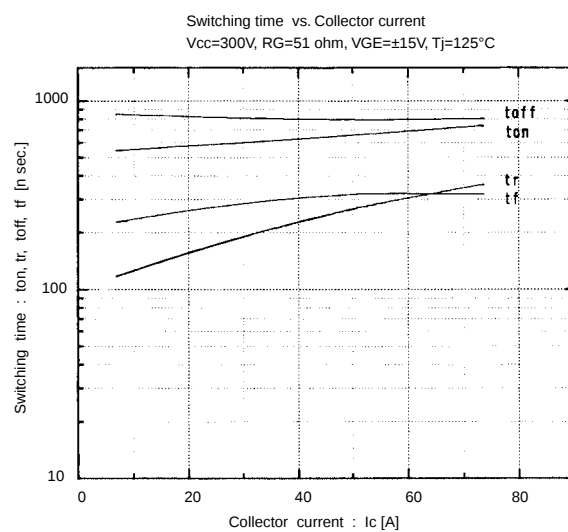
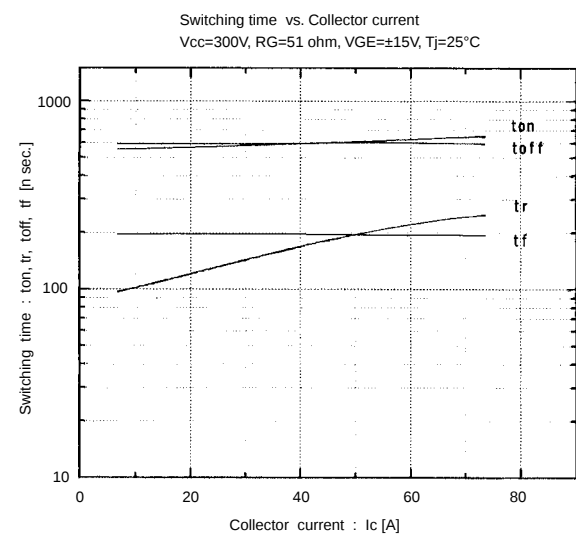
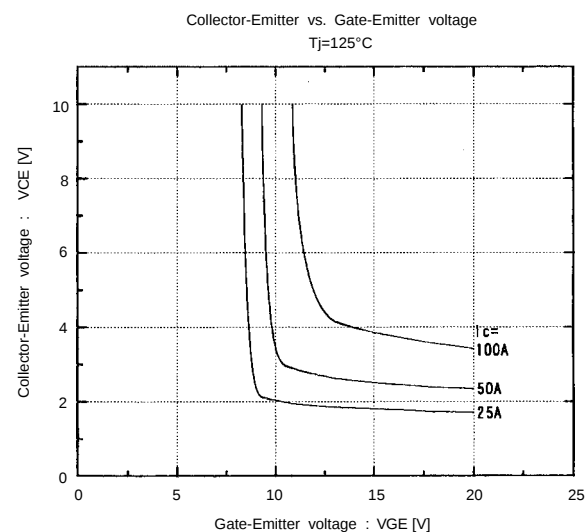
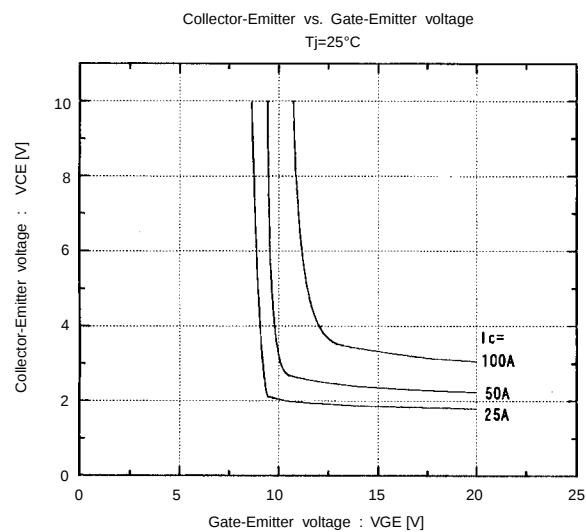
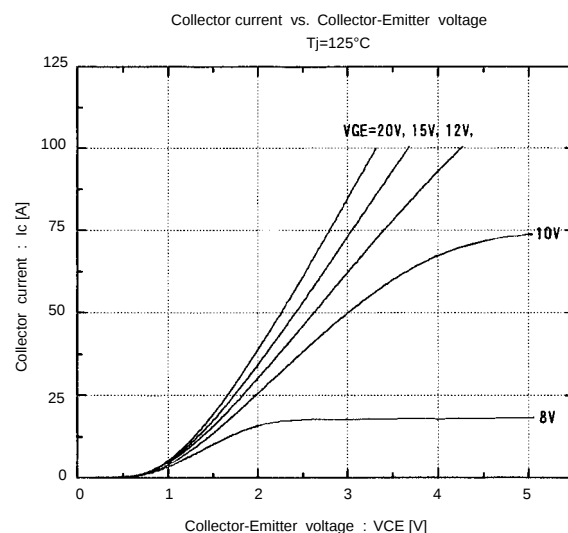
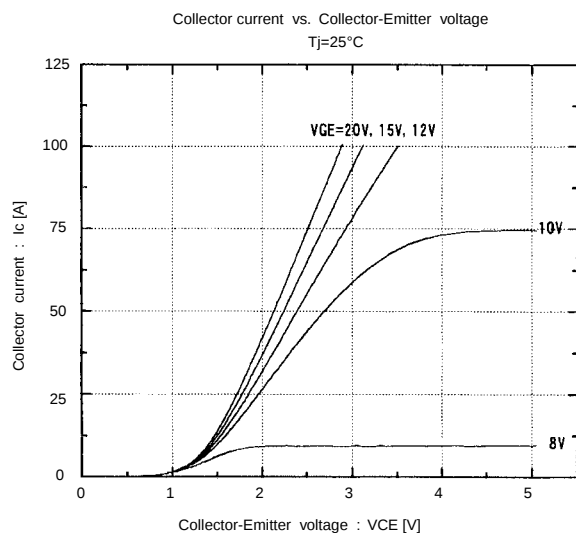
Item	Symbol	Condition	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance (1 device)	Rth(j-c)	Inverter IGBT			0.63	°C/W
		Inverter FRD			1.60	
		Brake IGBT			0.63	
		Converter Diode			2.10	
Contact thermal resistance *	Rth(c-f)	With thermal compound		0.05		

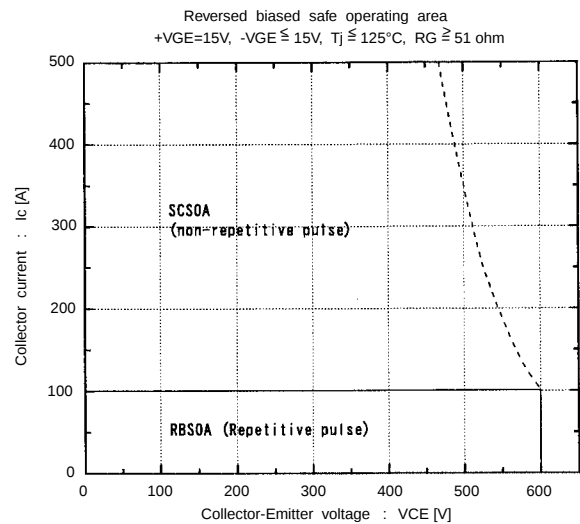
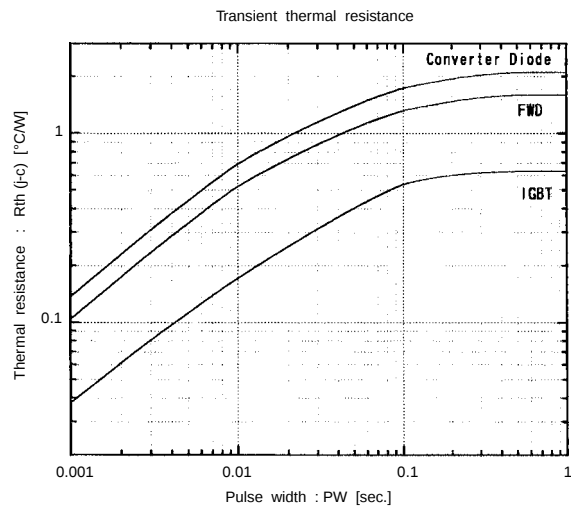
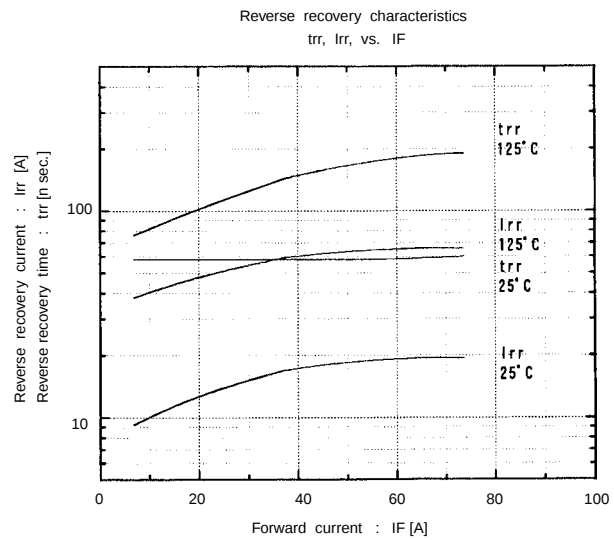
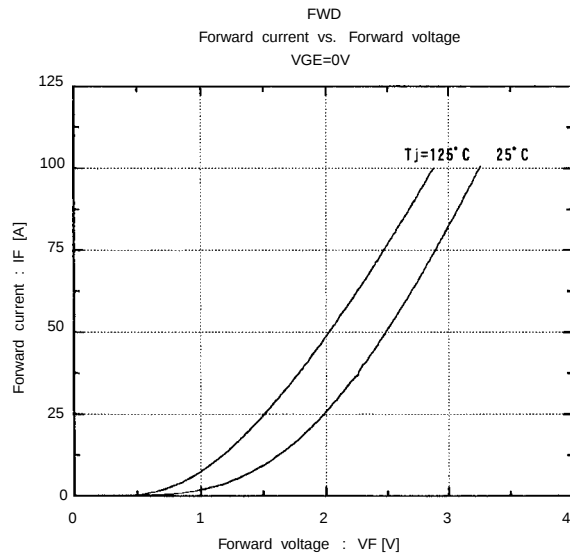
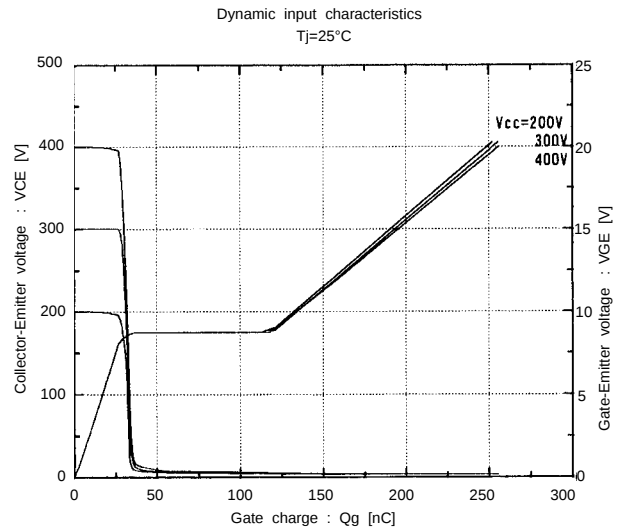
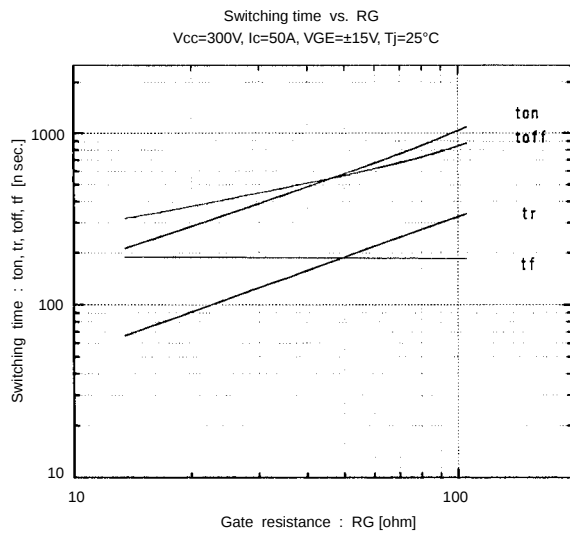
* This is the value which is defined mounting on the additional cooling fin with thermal compound

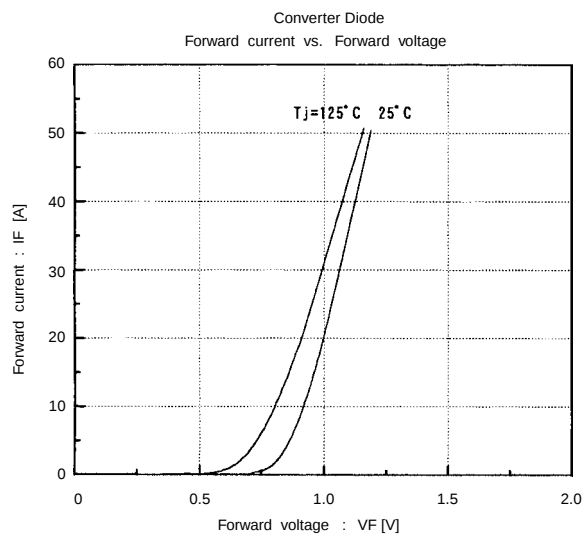
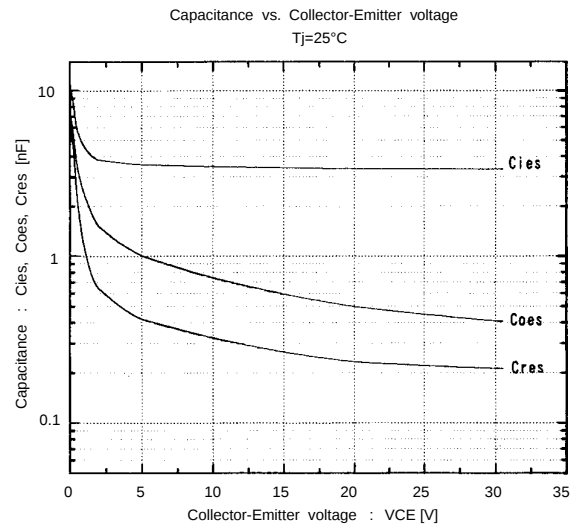
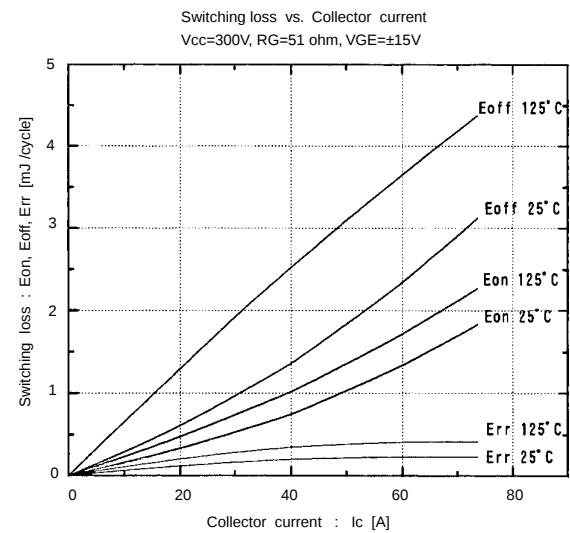
■ Equivalent Circuit Schematic



Characteristics (Representative)







■ Outline Drawings, mm

